New thick Silicon Carbide detectors: response to 14 MeV neutrons and comparison with single-crystal diamonds

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27 Abstract

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29 In this work we present the response of a new large volume 4H Silicon Carbide (SiC) detector to 14 30 MeV neutrons. The device has an active thickness of 100 μ m (obtained by epitaxial growing) and an active area of 25 mm². Tests were conducted at the ENEA-Frascati Neutron Generator facility by 31 32 using 14.1 MeV neutrons. The SiC detector performance was compared to that of Single-Crystal 33 Diamond (SCD) detectors. The SiC response function was successfully measured and revealed a very 34 complex structure due to the presence in the detector of both Silicon and Carbon atoms. 35 Nevertheless, the flexibility in the SiC manufacturing and the new achievements in terms of relatively large areas (up 1x1 cm²) and a wide range of thicknesses makes them an interesting 36 alternative to diamond detectors in environments where limited space and high neutron fluxes are 37 an issue, i.e. modern neutron cameras or in-vessel tokamak measurements for the new generation 38 39 fusion machines such as ITER. The absence of instabilities during neutron irradiation and the capability to withstand high neutron fluences and to follow the neutron yield suggest a 40 straightforward use of these detectors as a neutron diagnostics. 41

1. Introduction

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The range of application of high band-gap solid state detectors is expanding in those environments where the high neutron flux is an issue, such as in the high-flux spallation neutron sources and in the thermonuclear fusion environment. An example of the former is the ISIS spallation neutron source (Didcot, U.K.)[1], where neutrons are produced by 800 MeV protons impinging on a heavy material. Being a pulsed neutron source, instant neutron flux can be very high, therefore the smallsize and the fast response-time features of high band-gap solid state detectors make them an interesting solution to monitor and measure the neutron flux. Single-crystal Diamond (SCD) 51 detectors have been characterized in the past [2][3][4] and they are currently installed at the ChipIr 52 beam-line at ISIS as beam monitors [5]. ChipIr, built for measuring the Single Events Effects on electronic devices, is a fast neutron beam-line that directly faces the spallation target: the neutron 53 flux exceeds 10⁶ n/s cm² above 10 MeV and therefore dedicated fast-neutron detectors are still in 54 55 development for the measurement of the neutron flux in the 1-800 MeV energy range and able to 56 work at high rates (> 1 MHz). 57 As for thermonuclear fusion environments, it has been shown that SCDs can be used as excellent 58 spectrometers for 14 MeV neutrons [6] and a SCD detector matrix has been installed, e.g., at JET

(Joint European Torus) for the diagnosis of the plasma in the upcoming Deuterium-Tritium campaign [7]. Measurements performed with Deuterium (D) plasmas at JET have demonstrated that spectroscopy with a moderate energy resolution can also be performed [8][9] with 2.5 MeV neutrons. The limited availability of large size commercial single-crystal diamonds has led to the development of a 12-pixel (4.5 x 4.5 mm² each) matrix to boost the counting rate, especially in D plasmas, instead of having a single diamond detector with equal area.

Diamond detectors have been shown to withstand neutron fluence up to 2*10¹⁴ n/cm² as shown in [10] for single crystal and in [11] for polycrystalline diamonds. The latter, after irradiation with 8*10¹⁴ n/cm², recovers up to 70% of their initial performance after a suitable annealing. Moreover, transient effects have been noticed for SCD detectors irradiated with high energy neutrons and alpha particles [13][14]. Transient effects are due to partial trapping of the charge carries within the detector bulk defects and in the interfaces between the diamond crystal and the ohmic contacts.

71 These are known as polarization effects and depend on the type, and amount, of crystal defects,

- naturally present or induced by neutron irradiation [15][16]. The polarization effect can be reset by
 inverting the bias voltage, as discussed in [14], but it could affect energy resolution if not accounted
- 74 for.

In this paper we investigate the performance of new SiC detectors as an alternative to SCDs. SiC
devices have been already used in the past to measure the thermal neutron flux in reactors [17] and

the 14 MeV neutrons from DT reactions [18]. As shown in [19] good quality SiC detectors are now
available and measurement of the fast neutron spectrum is possible also at high temperatures as
done with diamond detectors [20].

80 The device used in present work was manufactured by SiCILIA (*Silicon Carbide detectors for Intense*

- 81 *Luminosity Investigations and Applications*) [21] project which is a collaboration between IMM-CNR
- and INFN totally funded by INFN. The main goal of the project was the processes innovation and
 production of relatively large area SiC detectors for many applications [22][23][24][25][26][27], with
- thicknesses depending on the experiment requirements. Today, thanks to the SiCILIA R&D, SiC can
- 85 be produced in relatively large areas (up to 1.5 cm²) [28] and with thicknesses up to 250 μ m which
- 86 represent an excellent enhancement in the SiC growth technology. Moreover in the near future they
- 87 could be worked in Geiger mode, in order to detect single photons [29][30].
- 88 Moreover, the possibility of growing SiC layers with large area and with different thickness, makes 89 this material an interesting candidate for applications in fusion plasma physics, like for instance for 90 Fast lons Loss Detectors (FILD) that measure the fast ions lost by the plasma before they hit the first 91 wall. Currently, FILD systems are based on scintillator crystals coupled to optical fibres leading 92 scintillation light towards a CDD [12]. They work in an environment where neutrons are the highest 93 source of background. An advantage of SiC in this application is that, by decreasing the crystal 94 thickness, the detector efficiency for neutrons can be accordingly decreased to as low as 10⁻⁵, 95 without losing efficiency for 500 keV ions.
- 96 As in SCDs, neutron detection in SiC is based on the collection of electron-hole pairs produced by
- 97 charged particles generated by neutron interaction with C and Si nuclei. Due to their abundances in
- 98 natural C and Si, in this work we will consider only interaction on ¹²C and ²⁸Si. This paper describes

measurements performed at the Frascati Neutron Generator (FNG) at Enea (Frascati, Italy) by using
 a SiCILIA SiC detector prototype and two SCDs with different thicknesses irradiated by 14 MeV
 neutrons. The SiC detector was irradiated up to a total fluence of 4.45*10¹¹ neutrons/cm².

102 The paper is organized as follows: in Section 2 the neutron-induced reactions on ¹²C and ²⁸Si are

summarized and the detectors are compared in terms of construction parameters and features. In

104 Section 3 the experiment performed at FNG is described, while in Section 4 the most important

105 results will be illustrated.



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Figure 1 Cross section of the SiC detectors

109 **2.** The detectors

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111 A. Detectors production

113 The SiC detectors were designed and manufactured at the CNR-IMM (Institute for Microelectronics 114 and Microsystems) in Catania, starting from the growth of thick 4H epitaxial layers on four inch 4H-115 SiC wafers by means of a CVD (Chemical Vapour Deposition) process. During this phase dopants are 116 provided by means of gaseous precursors such as N₂ for n-type doping and Al₂(CH₃)₆ 117 (Trimethylaluminium) for p-type doping in order to realize p-n junction devices. The process was 118 performed at a low-pressure and high temperature (1630 °C) regime.

119 The wafers were subsequently treated with several photolithographic steps, a first 120 photolithography for the definition of the detector area by Inductive Coupled Plasma (ICP) etching 121 was performed. Then, a second lithography was performed for the construction of the edge 122 structures, aimed at reducing the electrical field at the device borders. The process continues with 123 the deposition of an isolation oxide and the opening of the contacts with a further photolithographic 124 process and a subsequent annealing to perform a good electric contact on p^{\dagger} region. Along the 125 border of the active area of the detector a 200nm layer of Ti and Al was deposited in order to obtain a region well-suited for ultrasonic micro-bonding. Finally, the ohmic contact was formed by 126 127 Titanium/Nickel/Gold deposition. A cross-section of the SiC detector used for the neutron 128 measurements described in this paper is shown in Fig.1. It features a 300 nm thick p-layer with a doping concentration $N_A=1x10^{19}$ cm⁻³ and a 100 μ m thick n-layer with a doping concentration, N_D , 129 between 8x10¹³cm⁻³ and 1x10¹⁴ cm⁻³. The detector has an active area of about 10x10 mm², 130 segmented in four regions of 5x5 mm², and was mounted on a PCB board (Figure 3 A) designed to 131 132 be housed in an aluminium box.

133 The SCD detectors were designed and built at the CNR-IFP (Institute of Plasma Physics) in Milan and 134 at the CNR-ISM institute in Rome (Italy) [31][32][33]. The first SCD is made of a single-crystal diamond sample (4.5x4.5x0.5 mm³) grown with a CVD technique with boron concentration [B] <5 135 ppb and nitrogen concentration [N] <1 ppb), provided by Element Six Ltd. [34]. The second, equal 136 to the first one, has been thinned by laser cutting to a layer thickness of 150 μ m. Ohmic contacts 137 138 were obtained on the top and bottom surfaces of the samples by subsequent sputtering depositions 139 of a multilayer metal structure (patent pending), followed by a final gold layer deposition, in order 140 to improve weldability with microwires and to prevent oxidation of the underlying structure. The 141 contact thickness is 200 nm with a lateral dimension of $4.2x4.2mm^2$. A dedicated 1mm thick alumina 142 Printed Circuit Board (PCB) was designed and fabricated; the bottom surfaces of the diamond 143 samples were glued with a thin layer of conductive silver paste on the pad, whereas the top surfaces 144 were wire-bonded (by means of 25 μ m thick Al/Si wires) on the ground plane. The alumina PCB is 145 housed inside a properly designed aluminium metal case in order to shield it from electromagnetic 146 interference and to give the detectors the mechanical resistance necessary for handling.

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Figure 2 Cross sections for neutron interaction on Carbon (left) and on Silicon (right). Data from the ENDF/B-VI.0 for ¹²C and ENDF/B-VIII.0 for ²⁸Si[35].

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A. Neutron detection

154 Neutron detection is based on the collection of the electron-hole (e-h) pairs produced by neutron interaction with ¹²C in SCDs and with both ¹²C and ²⁸Si in SiC detectors. The most important reactions 155 induced by neutrons in the MeV energy range on Carbon and Silicon are reported in Table 1 and 156 157 their cross-sections in Figure 2. The most relevant neutron-induced process in both Carbon and 158 Silicon is the *elastic scattering* (black lines in Figure 2), in which only a fraction of the neutron energy 159 is released into the detector, by means of the energy of the recoiling atom, given by 160 $E_d = E_n * \cos\theta(4A)/(1+A)^2$, where E_n is the incoming neutron energy, θ is the recoil angle and A the mass number of the recoiling atom. The maximum energy that can be released into the detector is 161 162 E_{d,max}=4.00 MeV and E_{d,max}=1.87 MeV for recoils of Carbon and Silicon ions, respectively. All the energy values smaller than E_{d,max} can possibly be released by this process into the detector; as a 163 consequence, a typical edge-type shape is produced into the Pulse Height Spectrum (PHS) of the 164 detector. Concerning the reactions ${}^{A}X(n,\alpha)^{A-3}Y$ and ${}^{A}X(n,p)^{A}Y$, being two-body reactions, all the 165 166 neutron energy minus the reaction Q-value is deposited into the detector.

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168 Table 1: Main 14 MeV neutron-induced reactions on Carbon and Silicon. For each reaction, the threshold, the Q-value and the position of the peak in the PHS are given. The last column is the label of the peak observed in the experimental PHS shown in *Figure* 6. If the nucleus is left in an excited state the energy which can be released into the detector is given for the first nine excited states.

Reaction	Threshold	Q _{value} [MeV]	E _d [MeV]	Label
¹² C(n,n) ¹² C	-	-	E _{d,max} =4.0	0
¹² C(n ,α) ⁹ Be	6.2	-5.702		
	Ground state		8.398	1
	1st excite	ed state	6.761	
¹² C(n,p) ¹² B	13.645	-12.587		
	Ground state		1.513	
	1st excited state		0.56	

¹² C(n,n')3α	7.886	-7.275	6.825	2
²⁸ Si(n, n) ²⁸ Si	-	-	E _{d,max} =1.87	
²⁸ Si(n, α) ²⁵ Mg	2.749	-2.654		
	Ground state		11.446	3a
	1st excited state		10.861	3b
	2nd excited state		10.471	3c
	3rd excited state		9.834	3d
	4th excited state		9.481	3e
	5th excited state		8.644	3f
	6th excited state		8.041	3g
	7th excited state		8.032	3h
	8th excited state		7.538	3i
	9th excited state		7.475	Зј

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3. **Experimental set-up**

175 The response function of both SCDs and of the SiC detector, together with their neutron resistance 176 and stability, has been investigated by irradiating the detectors with 14.1 MeV neutrons at FNG. 177 Here, neutrons are produced by Deuterium-Tritium (DT) reactions obtained from deuterium ions 178 accelerated up to 300 keV impinging on a tritiated-titanium target [36]. The detectors were placed 179 at 90 degrees with respect to the beam direction (see Figure 3) at a distance between 13 and 18 cm 180 from the target. The expected neutron spectrum at the detector position, calculated through MCNP 181 simulations [37], features a main component, peaked at 14.1 MeV with a 130 keV broadening and 182 a scattered neutron component at lower energies (see Figure 4).

During the measurements, the FNG neutron yield has been monitored as a function of time by the 183 184 standard FNG monitor which detects the alpha particles produced by the DT reactions in the target. 185



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Figure 3 Pictures of the Silicon Carbide (A) and Single-crystal Diamond (B) detectors and their installation at the FNG facility (C). The 188 SiC detector used for the measurement was the one labelled "A" in the top left panel.

189 A dedicated custom electronic chain was used to bias and collect charge carriers from each detector. 190 In particular, the SCDs were coupled (through a 5 cm RG62 cable) to a CIVIDEC C6 fast charge 191 preamplifier [38] with rise time of 3.5 ns and a shaping time of 25 ns. Signals were directly fed into 192 a CAEN DT5730B digitizer (500 MSample/s and 14 bits) equipped with CAEN software able to 193 perform on-line measurements of the pulse area [39].

The SiC spectrometer was connected to an ORTEC 142A preamplifier [40] with nominal decay time of 500 μs; the signal from it was fed into an ORTEC 570 amplifier [40] which provided a gain factor of 1000 and a shaping time of 1 μs. Finally, the signal was recorded and analysed in amplitude by a MAESTRO multi-channel analyser (MCA) [40]. Alternatively, for some measurements, the SiC was preamplified by a CX-L CIVIDEC spectroscopic amplifier producing a Gaussian output signal of 180 ma 5M/UM [20] and there directly disting doubted by the CAEN DTE 720D.

ns FWHM [38] and then directly digitized by the CAEN DT5730B.

200 Both the SCDs and the SiC detectors were biased by a CAEN NDT1470 [39] HV Module. A bias voltage

201 V_{bias} equal to +400V and +120V was used to polarize the 500 μ m and the 150 μ m thick SCDs,

202 respectively, giving rise to a constant electric field in the whole SCDs bulk of $0.8V/\mu$ m. A V_{bias} equal

203 to -400V was used to polarize the SiC creating a depletion region of 73 μ m.



Figure 4 FNG Neutron spectrum expected at the SiC position. The spectrum, reported in logarithmic (left) and linear (right) scale, is
 peaked at 14.1 MeV with a 130 keV broadening.

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4. Measurements with 14 MeV neutrons

210 The PHS measured with the two SCDs (Figure 5) feature the characteristic structures of neutron 211 interaction with Carbon described in Section 2. A prominent peak, due to the ${}^{12}C(n,\alpha)^9$ Be reaction, 212 is clearly visible at 8.4 MeV. This peak features a FWHM of 203 keV and 191 keV for the two SCDs 213 (500 and 150 μ m), respectively: taking into account the 130 keV FWHM of the beam, an energy 214 resolution of 1.84% and 1.67% for the 500 μ m and the 150 μ m diamond has been obtained, 215 respectively. At lower energies, three edges can be observed. The one at 6.8 MeV is due the carbon break-up reaction into three α particles, ¹²C(n,n')3 α . The edge at 4 MeV is due to the elastic recoil 216 on ¹²C, while the structure between 2.7 MeV and 3.3 MeV is due to a combination of *i*) elastic recoil 217 218 at higher recoiling angles, ii) elastic recoil leaving carbon in the first excited state and iii) the carbon 219 break-up reaction. Although, the two SCDs show a very similar PHS shape, a clear discrepancy 220 between the two SCDs is observed in the lower energy part of the spectrum. This discrepancy, also 221 visible in the (n,α) peak, is still under investigation and it could be due to the "wall" effect [41] 222 related to the different diamond thickness.

If the PHS are observed in logarithmic scale, a peak at 10.3 MeV is clearly visible above the background. This peak is due to the ${}^{13}C(n,\alpha){}^{10}Be$ reaction, which has a lower Q-value (-3.83 MeV) with respect to the (n,α) reaction on ${}^{12}C$. Its intensity is limited to 0.5% of the (n,α) peak on ${}^{12}C$ by both its lower cross-section and the low natural abundance of ${}^{13}C$ (1.1%). These events limit the SCDs sensitivity on the high energetic ions in DT plasmas to about 10⁻² with respect to main bulk emission as mentioned in [42].

The SiC PHS shows a more complicated structure due to the presence of the ²⁸Si, in particular, neutron interaction via (n, α) and (n,p) reactions on ²⁸Si can leave the ²⁵Mg and ²⁸Al nuclei on either 231 the ground state or the first excited states with different finite probabilities. This results in a number of peaks in the PHS that, together with the neutron-induced reactions on ¹²C, give the spectra in 232 Figure 6. The most important structures in the PHS have been labelled as in Table 1 in order to 233 improve the comprehension of the spectrum. The most intense peak is placed at E_d=8.4 MeV and it 234 is related to the (n,α) reaction on ¹²C on the ground state. The same reaction channel on ²⁸Si can be 235 observed at E_d=11.4 MeV. The intensity of this peak is limited with respect to the one occurring on 236 ^{12}C because the (n, α) reaction can produce ^{25}Mg in an excited energy level (contributions 237 corresponding to excited levels up to the 9th can be recognized in Fig.6). 238





Figure 5 PHS for the 150 μ m thick diamond (blue line) and the 500 μ m thick diamond (black line) in linear (left) and log scale (right). The left Y-axis refers to the spectrum obtained with the 500 μ m SCD, while the right one refers to the 150 μ m thick SCD. The spectra have been normalized with respect to the neutron fluence (1.1 ± 0.2 *10¹⁰ n/cm² for the 500 μ m diamond 2.6 ± 0.4*10¹⁰ n/cm² for the 150 μ m diamond) and to the bin width is equal to 22 keV.



Figure 6 Pulse Height spectrum for the SiC in linear and log scale obtained with the ORTEC 142A preamplifier and 570 amplifier. The spectra have been normalized with respect to the neutron fluence $(2.4 \pm 0.3 \times 10^{10} \text{ n/cm}^2)$ and the bin width is 22 keV. The labels in the log scale spectrum refer to the different reactions summarized in *Table 1*.

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At lower deposited energies the elastic edge on ¹²C, placed at E_d =4 MeV is still visible, but the same interaction channel on ²⁸Si, which should be placed at 1.87 MeV, cannot be distinguished from the background. The (n, α) peaks feature a FWHM of 265 keV for the reaction ¹²C(n, α)⁹Be and 365 keV for ²⁸Si(n, α)²⁵Mg when ²⁵Mg is produced in the ground state: taking into account the beam energy FWHM of 130 keV, an energy resolution of 2.7% and 3% has been obtained respectively for the two peaks. The energy resolution achieved is good enough for measuring the temperature in ohmic plasmas [43] where an energy resolution better that 5% is required.

257 Besides the energy resolution and the sensitivity of the (n,α) peak to high energy components of 258 the neutron spectrum, a crucial feature for neutron detectors is their efficiency. Two parameters

- 259 can be used to assess the efficiency: the overall counts above a certain energy threshold and the
- 260 counts corresponding to a specific reaction channel. Both methods have been used in this work. The
- 261 threshold used for the evaluation of the efficiency has been chosen equal to $E_d=1.2$ MeV for all the
- detectors in order to discard the gamma-ray background and the counts due to electronic noise.
- 263 The reaction channel used to compare the efficiency is the ${}^{12}C(n,\alpha)^{9}Be$ reaction producing the only
- 264 peak in common between the two kind of detectors. The measured efficiency is here compared with
- the results of GEANT4 simulations giving the results shown in shown in Table 2.
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Detector	Atomic/	Detector	Efficiency	Simulated	Efficiency	Simulated
	molecular	volume	measured for E _d >	efficiency for	measured in the	efficiency
	density	[cm ³]	1.2 MeV	E _d >1.2 MeV [and	12 C(n, α) ⁹ Be peak	in the
	[cm ⁻³]		[and normalized	normalized per		¹² C(n,α) ⁹ Be
			per atom]	atom]		peak
SCD 500	1.76*10 ²³	$1.0125*10^{-2}$	(5.32 ± 0.87) *10 ⁻³	5.2 *10 ⁻³	(3.98 ± 0.73) *10 ⁻⁴	5.45 *10 ⁻⁴
μm			[2.98 *10 ⁻²⁴]	[2.92 *10 ⁻²⁴]		
SCD 150	1.76*10 ²³	3.0375*10 ⁻³	$(1.59 \pm 0.25)*10^{-3}$	1.6 *10 ⁻³	$(0.91 \pm 0.15) * 10^{-4}$	1.47 *10 ⁻⁴
μm			[2.97 *10 ⁻²⁴]	[2.99 *10 ⁻²⁴]	()	
SiC 100 μm	4.8*10 ²²	2.5*10 ⁻³	(5.69± 0.78) *10 ⁻⁴ [4.74 *10 ⁻²⁴]	6.73*10 ⁻⁴ [5.61 *10 ⁻²⁴]	(2.02 ± 0.30) *10 ⁻⁵	2.73*10 ⁻⁵

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268Table 2 Efficiency measured and simulated for the three detectors for $E_d>1.2$ MeV and in the ${}^{12}C(n,\alpha)^9$ Be peak (note that for $E_d>1.2$ 269MeV the efficiency per atom is reported in square brackets). The error on the measured efficiency is the combination of the statistic270error, a 5% uncertainty on the measure of the neutron fluence and a 5% uncertainty due to the subtraction of the background.271Together with the values of the efficiency the detector volume and atomic/molecular density are reported.



Figure 7 150 μm diamond (left) and SiC (right) detector counting rate compared to FNG neutron yield, both binned every 40 seconds.
Note that the plots are in double Y scale: the left axis refers to the detectors counting rate while the right one refers to the neutron yield. The scale ratio between Y_{max} and Y_{min} is equal to 4 for all the plots.

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The most efficient detector among the ones examined is the 500 µm-thick diamond; this is due to the fact that the probability of neutron interaction scales with the volume of the detector and the material atomic density. The agreement between the simulated and the measured efficiency is rather good in all the considered cases especially for the overall efficiency. Moreover, the efficiency normalized to atom number indicates that the two SCD detectors behave the same when irradiated with fast neutrons; on the other hand, the higher normalized efficiency of the SiC reflects the higher neutron reaction cross section on Silicon.

The measured efficiency for the ${}^{12}C(n,\alpha)^9$ Be peak is always lower than the simulated one. This could be due to events with only a partial charge collection efficiency not contributing to the main peak. 286 It could also be due to discrepancies between the ${}^{12}C(n,\alpha)^9$ Be reaction cross section employed in 287 the simulation and the actual one.

Together with the efficiency evaluation, the stability of the detectors compared to the total FNG neutron yield was measured. The FNG neutron yield, monitored during the irradiation of all the detectors, showed a very good agreement in terms of counting rate with all the detectors (Figure 7). The Pearson correlation coefficients were calculated for the two detectors being equal to 0.9793 and 0.9770 for the diamond and the SiC respectively.

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5. Conclusion

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298 The Silicon Carbide detector produced within the SiCILIA project has been tested at FNG by using 299 14.1 MeV neutrons. The detector, featuring an active area of 25 mm² and an epitaxial thickness of 300 100 µm, showed good efficiency values thus demonstrating the improvements made in the growing procedures. The absence of instabilities during neutron irradiation up to a 14 MeV neutron fluence 301 of 4.45*10¹¹ n/cm² suggests a straightforward use of this detector as a fast neutron diagnostic. The 302 Pulse Height spectrum obtained from the SiC detector revealed a very complex response function 303 due to the presence of both ¹²C and ²⁸Si. This complexity limits the sensitivity of the SiC when used 304 as a neutron spectrometer for Deuterium-Tritium plasma diagnostics [7][42], though it could be well 305 306 suited to measure the temperature in thermal plasmas. Furthermore, it could be successfully used 307 as a neutron diagnostic in those environments in which small size is a requirement, such as in a 308 neutron camera. In addition, the possibility of growing Silicon Carbide layers with different 309 thicknesses allows for tuning the neutron detection efficiency, and, therefore, using SiC crystals as 310 charged particle detectors in those environments where high neutron fluxes are an issue, such as in 311 FILD detectors.

This work is the first step towards the realization of a fast neutron detector based on Silicon Carbide.More measurements are planned in order to measure the SiC detector response function to

neutrons of different energies as already done for diamond based detectors [45] and to assess the

detector radiation hardness as done in [10] with diamonds. The present work shows that the Silicon
 Carbide detector is able to withstand 14 MeV neutron irradiation without changing its performances

- 317 which is of particular relevance in the case of the future nuclear fusion machines, such as ITER [46].
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321 Acknowledgments

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The work leading to this publication was funded by the INFN-Group 5 (Technology Research) and by EuroFusion-WP-JT60SA. The views and opinions expressed herein do not necessarily reflect those

325 of Eurofusion and INFN.

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